



DMP3045LVT

Product Summary

BV _{DSS}	Rds(on) Max	I _D Max T _A = +25°C
-30V	42mΩ @ V _{GS} = -10V	-5.4A
-307	65mΩ @ V _{GS} = -4.5V	-4A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Backlighting
- Power Management Functions
- DC-DC Converters

P-CHANNEL ENHANCEMENT MODE MOSFET

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

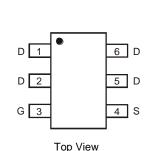
Mechanical Data

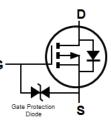
- Package: TSOT26
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish—Matte Tin Annealed over Copper Lead-Frame. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.013 grams (Approximate)





Top View





Equivalent Circuit

Ordering Information (Note 4)

Part Number	Baakaga	Packing		
Fait Nulliber	Package	Qty.	Carrier	
DMP3045LVT-7	TSOT26	3,000	Tape & Reel	
DMP3045LVT-13	TSOT26	10,000	Tape & Reel	

No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information

Π	Π	
66	P	ΥM
П		TT

 $\begin{array}{l} 66\mathsf{P} = \mathsf{Product Type Marking Code} \\ \mathsf{YM} = \mathsf{Date Code Marking} \\ \mathsf{Y or } \overline{\mathsf{Y}} = \mathsf{Year} \ (\mathsf{ex: I} = 2021) \\ \mathsf{M} = \mathsf{Month} \ (\mathsf{ex: 9} = \mathsf{September}) \end{array}$

Date Code Key

Notes:

Year	2020	2021	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	Н		J	K	L	М	Ν	0	Р	R	S	Т
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		Vdss	-30	V	
Gate-Source Voltage			Vgss	±20	V
Continuous Drain Current (Note 5) V_{GS} = -10V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	lo	-5.4 -4.3	A
Continuous Drain Current (Note 5) $V_{GS} = -4.5V$ State $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$			lD	-4.1 -3.2	A
Maximum Body Diode Continuous Current		ls	-2	A	
Avalanche Current (Note 7) L = 1mH	las	-7.8	A		
Avalanche Energy (Note 7) L = 1mH			Eas	30	mJ

Thermal Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 6)		PD	1.2	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _{0JA}	104	°C/W
Total Power Dissipation (Note 5)		PD	1.6	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{0JA}	78	°C/W
Thermal Resistance, Junction to Case (Note 7)	Steady State	Rejc	19.6	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)	,		51	1			
Drain-Source Breakdown Voltage	BVDSS	-30	_		V	$V_{GS} = 0V, I_{D} = -250 \mu A$	
Zero Gate Voltage Drain Current @ T _J = +25°C	IDSS		_	-1	μA	V _{DS} = -24V, V _{GS} = 0V	
Gate-Source Leakage	Igss	_		±10	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	VGS(TH)	-1	—	-2.1	V	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$	
Static Drain-Source On-Resistance	Descer	—	28	42	mΩ	VGS = -10V, ID = -4.9A	
Static Drain-Source On-Resistance	RDS(ON)	_	47	65	1112	$V_{GS} = -4.5V, I_D = -3.7A$	
Diode Forward Voltage	V _{SD}	_	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance		_	749	—			
Output Capacitance	Coss	_	114	—	pF	V _{DS} = -15V, V _{GS} = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	79	—			
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	7	—			
Total Gate Charge (V _{GS} = -10V)	Qg	_	14.3	—		$V_{DS} = -15V, I_D = -4.9A$	
Gate-Source Charge	Qgs	_	2.4	—	nC		
Gate-Drain Charge	Qgd	_	3	—]		
Turn-On Delay Time	td(on)	_	4.4	—			
Turn-On Rise Time	tR	_	19.7	_]	V _{DD} = -15V, V _{GS} = -10V,	
Turn-Off Delay Time	tD(OFF)	_	27.5	_	ns	$I_D = -4.9A, R_G = 6\Omega$	
Turn-Off Fall Time	tF	_	26	_	1		

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

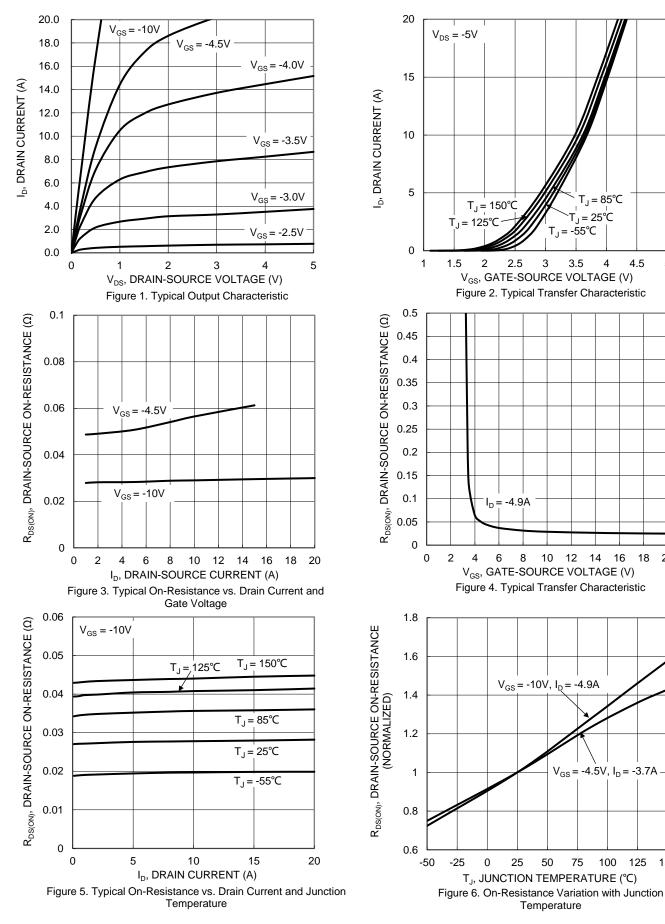
7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.



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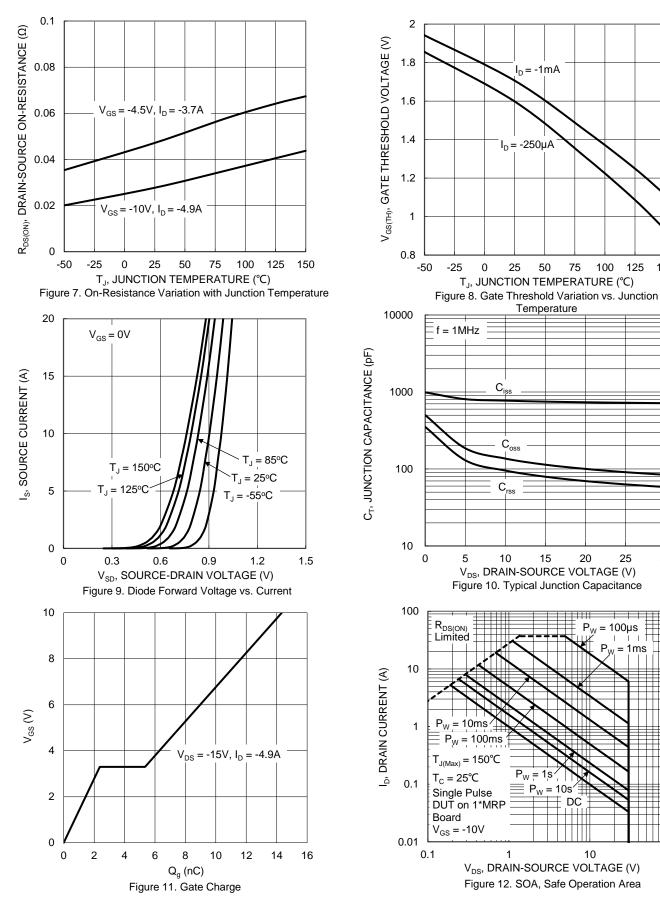
150



DMP3045LVT

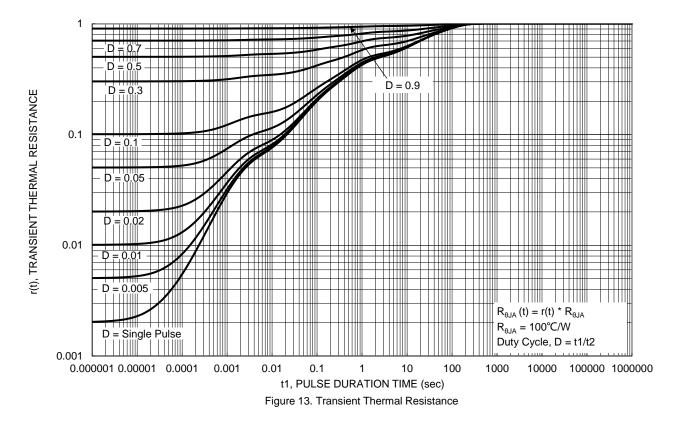
150

30



100

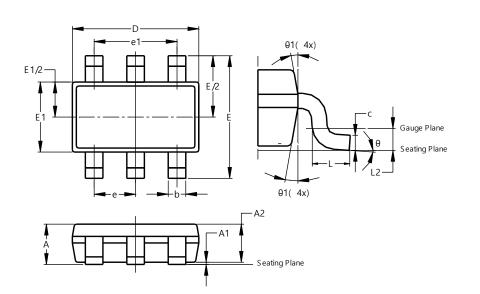






Package Outline Dimensions

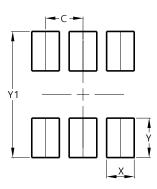
Please see http://www.diodes.com/package-outlines.html for the latest version.



	TSOT26							
Dim	Min Max Typ							
Α	-	1.00	-					
A1	0.010	0.100	-					
A2	0.840	0.900	-					
D	2.800	3.000	2.900					
ш	2	.800 BS	C					
E1	1.500	1.700	1.600					
b	0.300	0.450	-					
С	0.120	0.200	-					
e	0.950 BSC							
e1	1	1.900 BSC						
L	0.30	0.50	-					
L2	0	.250 BS	C					
θ	0°	8°	4°					
θ1	4°	12°	-					
A	II Dimen	sions in	mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



TSOT26

TSOT26

Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.200



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